



DMN1006UCA6

#### N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

BVsss	Rss(ON) Typ	Is мах Та = +25°С
12V	5.3mΩ @ V <sub>GS</sub> = 3.8V	16.6A

#### Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{SS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

## Applications

- Battery Management
- Load Switch
- Battery Protection

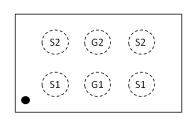
#### Features

- CSP with Footprint 2.70mm × 1.81mm
- Height = 0.21mm for Low Profile
- ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

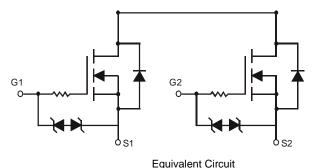
#### **Mechanical Data**

- Case: X3-DSN2718-6
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0026 grams (Approximate)





X3-DSN2718-6



Top View

## Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1006UCA6-7	X3-DSN2718-6	3000/Tape & Reel

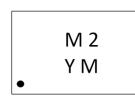
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See http://www.diodes.com/quality/lead\_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



 $\begin{array}{l} M2 = \mbox{Product Type Marking Code} \\ YM = \mbox{Date Code Marking} \\ Y \mbox{ or } \overline{Y} = \mbox{Year (ex: G = 2019)} \\ M \mbox{ or } \overline{M} = \mbox{Month (ex: 9 = September)} \end{array}$ 

#### Date Code Key

	<i>,</i> y											
Year	2017	2018	20	019	2020	2021	1	2022	2023	202	24	2025
Code	E	F		G	Н			J	K	L	-	М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Source-Source Voltage	Vsss	12	V		
Gate-Source Voltage			Vgss	±12	V
	Steady State	T <sub>A</sub> = +25°C	ls	16.6	•
Continuous Source Current (Note 5) $V_{GS} = 4.5V$		T <sub>A</sub> = +70°C		13.2	A
	Steady	T <sub>A</sub> = +25°C		12.1	٨
Continuous Source Current (Note 5) $V_{GS} = 2.5V$	State	T <sub>A</sub> = +70°C	Is	9.7	A
Pulsed Source Current (Note 6)	lsм	80	А		

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	1.0	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 7)	Reja	124.6	°C/W
Power Dissipation (Note 5)	PD	2.4	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	Reja	51.5	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)					1		
Source-Source Breakdown Voltage	BV <sub>SSS</sub>	12	_		V	$V_{GS} = 0V, I_S = 1mA$	
Zero Gate Voltage Drain Current TJ = +25°C	Isss	—	—	1	μA	$V_{SS} = 10V V_{GS} = 0V$	
Gate-Source Leakage	lgss	—	_	±10	μA	$V_{GS} = \pm 8V, V_{SS} = 0V$	
ON CHARACTERISTICS (Note 8)	·		•				
Gate Threshold Voltage	VGS(TH)	0.5	_	1.3	V	Vss = 6V, $Is = 1mA$	
		3.5	5.0	5.9		VGS = 4.5V, IS = 3A	
		3.6	5.2	6.3	mΩ	$V_{GS} = 4.0V, I_{S} = 3A$	
Static Source-Source On-Resistance	Rss(ON)	3.8	5.3	6.5		VGS = 3.8V, IS = 3A	
		3.8	5.5	8.0		VGS = 3.1V, IS = 3A	
		4.2	6.0	9.0		Vgs = 2.5V, Is = 3A	
Diode Forward Voltage	Vss	_	0.7	1.2	V	$V_{GS} = 0V, I_S = 3A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	2,360	—			
Output Capacitance	Coss	—	666	—	pF	Vss = 6V, Vgs = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	325				
Total Gate Charge	Qg	_	35.2				
Gate-Source Charge	Qgs	—	7.0	—	nC	$V_{SS} = 6V, V_{GS} = 4.5V,$	
Gate-Drain Charge	Q <sub>gd</sub>	—	8.3	_	nc	Is = 18A	
Gate Charge at V <sub>TH</sub>	Q <sub>g(TH)</sub>		4.2				
Turn-On Delay Time	tD(ON)		615	—			
Turn-On Rise Time	t <sub>R</sub>		1,447			$V_{SS} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	tD(OFF)		2,736		ns	Is = 3A	
Turn-Off Fall Time	tF	—	3812	—	1		

Notes: 5. Device mounted on FR-4 material with 1inch<sup>2</sup> (6.45cm<sup>2</sup>), 2oz. (0.071mm thick) Cu.

6. Repetitive rating, pulse width limited by junction temperature.

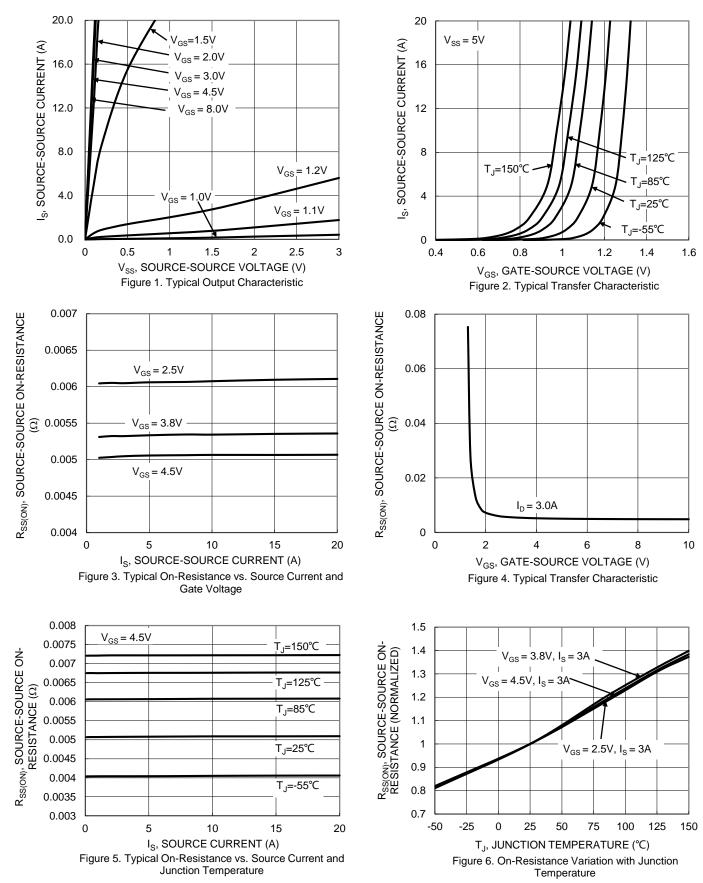
7. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to production testing.

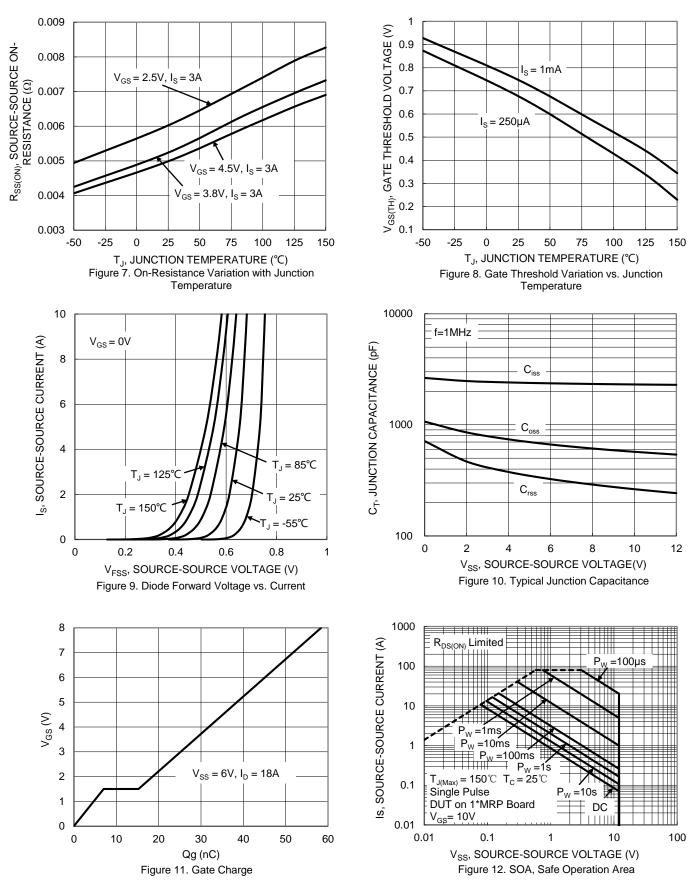


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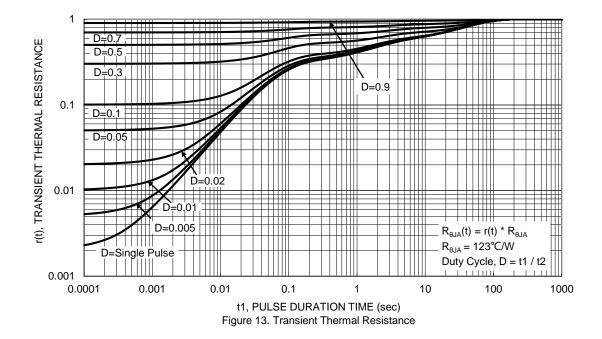


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DMN1006UCA6 Document number: DS39390 Rev. 7 - 2



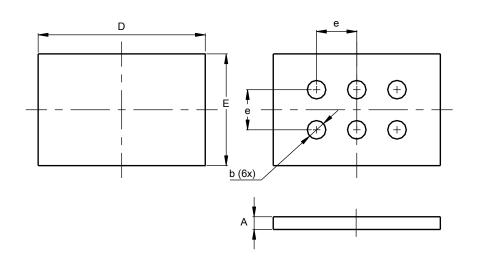




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X3-DSN2718-6

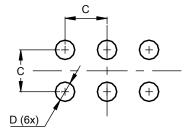


X3-DSN2718-6							
Dim Min Max Typ							
Α	0.16	0.26	0.21				
b	0.27	0.33	0.30				
D	2.65	2.75	2.70				
E	1.76	1.86	1.81				
е	0.62	0.68	0.65				
All Dimensions in mm							

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	0.65
D	0.30



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